

### Maximum Ratings (@T<sub>A</sub> = +25°C unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Current	IPP	3	А	8/20µs, per Figure 3
ESD Protection – Contact Discharge	V <sub>ESD_Contact</sub>	±10	kV	IEC 61000-4-2 Standard

## **Thermal Characteristics**

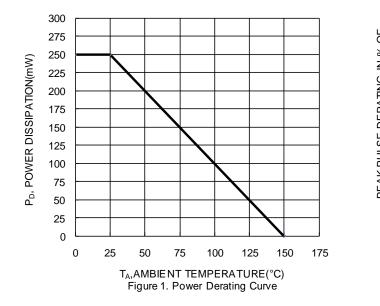
Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 6)	PD	250	mW
Thermal Resistance, Junction to Ambient (Note 6)	$R_{ heta}$ JA	500	°C/W
Operating and Storage Temperature Range	TJ, T <sub>STG</sub>	-65 to +150	۵°

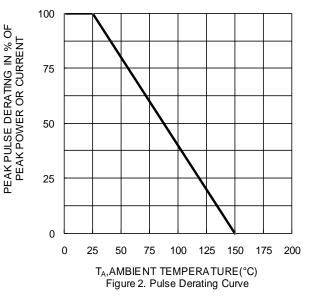
## Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Standoff Voltage	V <sub>RWM</sub>	-	-	5	V	-
Channel Leakage Current (Note 7)	I <sub>RM</sub>	-	5	100	nA	V <sub>RWM</sub> = 5V
Clamping Voltage	V <sub>CL</sub>	-	7.2	-	V	$I_{PP} = 3A, t_p = 8/20 \mu s$
Breakdown Voltage	V <sub>BR</sub>	5.5	7	9.5	V	$I_R = 5mA$
Differential Resistance	R <sub>DIF</sub>	-	-	100	Ω	I <sub>R</sub> = 1mA
Dynamic Impedance	Rdyn	-	0.3	-	Ω	TLP, 20A, tp = 100 ns
Channel Input Capacitance	0	-	2.9	-	- pF	$V_R = 0V, f = 1MHz$
	CT	-	1.9	-		$V_R = 5V$ , f = 1MHz

Notes: 6. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com.

7. Short duration pulse test used to minimize self-heating effect.







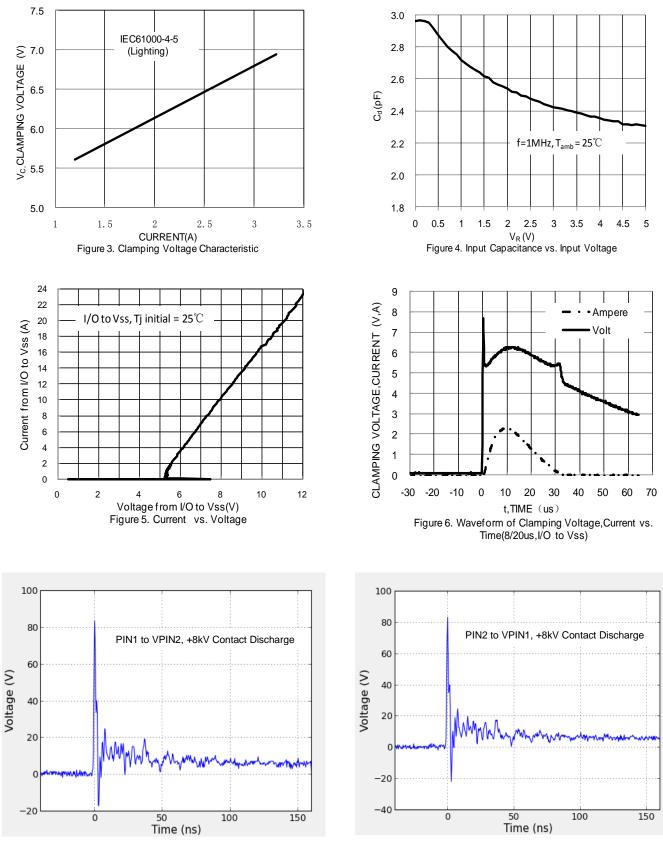
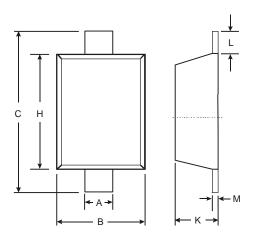


Figure 7 ESD response to IEC 61000-4-2



# Package Outline Dimensions

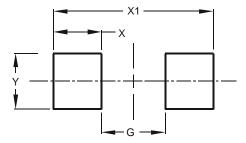
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SOD523			
Dim	Min	Max	
Α	0.25	0.35	
В	0.70	0.90	
С	1.50	1.70	
Н	1.10	1.30	
K	0.55	0.65	
L	0.10	0.30	
М	0.10	0.12	
All Dimensions in mm			

## Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
G	0.80
Х	0.60
X1	2.00
Y	0.70



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